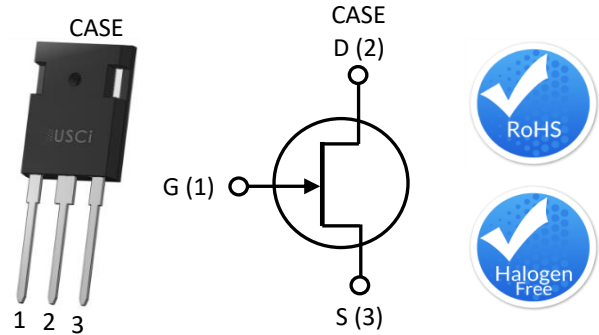


## Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ( $R_{DS(ON)}$ ) and gate charge ( $Q_G$ ) allowing for low conduction and switching loss. The device normally-on characteristics with low  $R_{DS(ON)}$  at  $V_{GS} = 0\text{ V}$  is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N065025K3S	TO-247-3L	UJ3N065025K3S

## Features

- ◆ Typical on-resistance  $R_{DS(on),typ}$  of 25mΩ
- ◆ Voltage controlled
- ◆ Maximum operating temperature of 175°C
- ◆ Extremely fast switching not dependent on temperature
- ◆ Low gate charge
- ◆ Low intrinsic capacitance
- ◆ RoHS compliant

## Typical Applications

- ◆ Over current protection circuits
- ◆ DC-AC inverters
- ◆ Switch mode power supplies
- ◆ Power factor correction modules
- ◆ Motor drives
- ◆ Induction heating

## Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	$V_{DS}$		650	V
Gate-source voltage	$V_{GS}$	DC	-20 to +3	V
		AC <sup>(1)</sup>	-20 to +20	
Continuous drain current <sup>(2)</sup>	$I_D$	$T_C = 25^\circ\text{C}$	85	A
		$T_C = 100^\circ\text{C}$	62	A
Pulsed drain current <sup>(3)</sup>	$I_{DM}$	$T_C = 25^\circ\text{C}$	250	A
Power dissipation	$P_{tot}$	$T_C = 25^\circ\text{C}$	441	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	$T_J, T_{STG}$		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	$T_L$		250	°C

(1) +20V AC rating applies for turn-on pulses <200ns applied with external  $R_G > 1\Omega$ .

(2) Limited by  $T_{J,max}$

(3) Pulse width  $t_p$  limited by  $T_{J,max}$

**Electrical Characteristics** ( $T_J = +25^\circ\text{C}$  unless otherwise specified)

**Typical Performance - Static**

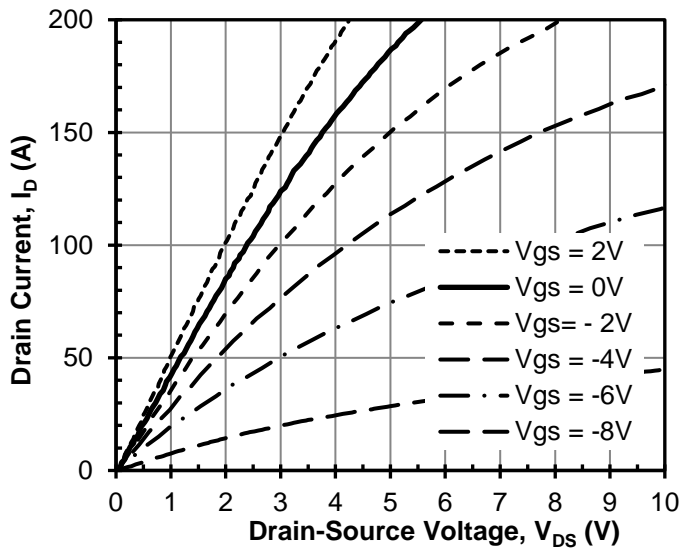
Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	$BV_{DS}$	$V_{GS} = -20\text{V}, I_D = 1\text{mA}$	650			V
Total drain leakage current	$I_D$	$V_{DS} = 650\text{V},$ $V_{GS} = -20\text{V}, T_J = 25^\circ\text{C}$		10	60	$\mu\text{A}$
		$V_{DS} = 650\text{V},$ $V_{GS} = -20\text{V}, T_J = 175^\circ\text{C}$		40		
Total gate leakage current	$I_G$	$V_{GS} = -20\text{V}, T_J = 25^\circ\text{C}$		10	100	$\mu\text{A}$
		$V_{GS} = -20\text{V}, T_J = 175^\circ\text{C}$		38		
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 2\text{V}, I_D = 20\text{A},$ $T_J = 25^\circ\text{C}$		22		$\text{m}\Omega$
		$V_{GS} = 0\text{V}, I_D = 20\text{A},$ $T_J = 25^\circ\text{C}$		25	33	
		$V_{GS} = 2\text{V}, I_D = 20\text{A},$ $T_J = 175^\circ\text{C}$		38		
		$V_{GS} = 0\text{V}, I_D = 20\text{A},$ $T_J = 175^\circ\text{C}$		43		
Gate threshold voltage	$V_{G(th)}$	$V_{DS} = 5\text{V}, I_D = 70\text{mA}$	-14	-11.5	-6	V
Gate resistance	$R_G$	$f = 1\text{MHz}, \text{open drain}$		2.5		$\Omega$

**Typical Performance - Dynamic**

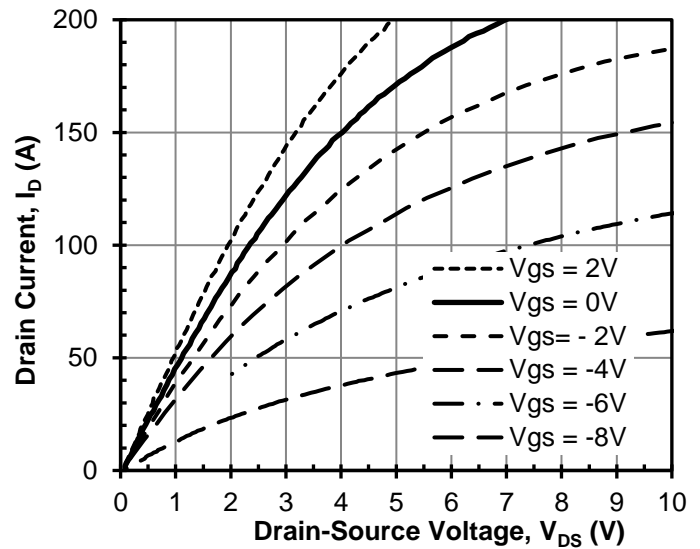
Parameter	symbol	Test Conditions	Value			Units	
			Min	Typ	Max		
Input capacitance	$C_{iss}$	$V_{DS} = 100V,$ $V_{GS} = -20V,$ $f = 100kHz$		2360		pF	
Output capacitance	$C_{oss}$			290			
Reverse transfer capacitance	$C_{rss}$			282			
Effective output capacitance, energy related	$C_{oss(er)}$	$V_{DS} = 0V$ to 400V, $V_{GS} = -20V$		210		pF	
Total gate charge	$Q_G$	$V_{DS}=400V, I_D = 60A,$ $V_{GS}=-18V$ to 0V		240		nC	
Gate-drain charge	$Q_{GD}$			134			
Gate-source charge	$Q_{GS}$			24			
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V, I_D=60A,$ Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ3D06530TS $T_J = 25^\circ C$		11		ns	
Rise time	$t_r$			64			
Turn-off delay time	$t_{d(off)}$			43			
Fall time	$t_f$			44			
Turn-on energy	$E_{ON}$			740			$\mu J$
Turn-off energy	$E_{OFF}$			818			
Total switching energy	$E_{TOTAL}$			1558			
Turn-on delay time	$t_{d(on)}$	$V_{DS}=400V, I_D=60A,$ Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ3D06530TS $T_J = 150^\circ C$		11		ns	
Rise time	$t_r$			62			
Turn-off delay time	$t_{d(off)}$			38			
Fall time	$t_f$			41			
Turn-on energy	$E_{ON}$			663			$\mu J$
Turn-off energy	$E_{OFF}$			750			
Total switching energy	$E_{TOTAL}$			1413			

**Thermal Characteristics**

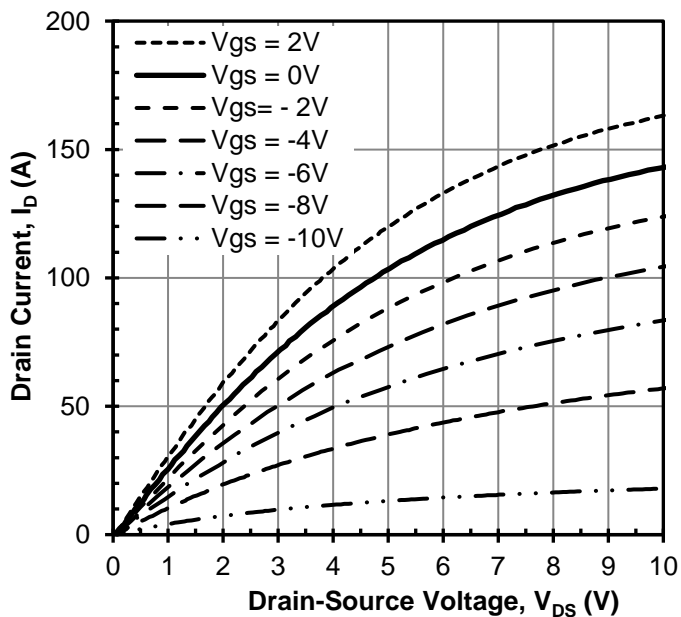
Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.26	0.34	$^\circ C/W$

**Typical Performance Diagrams**


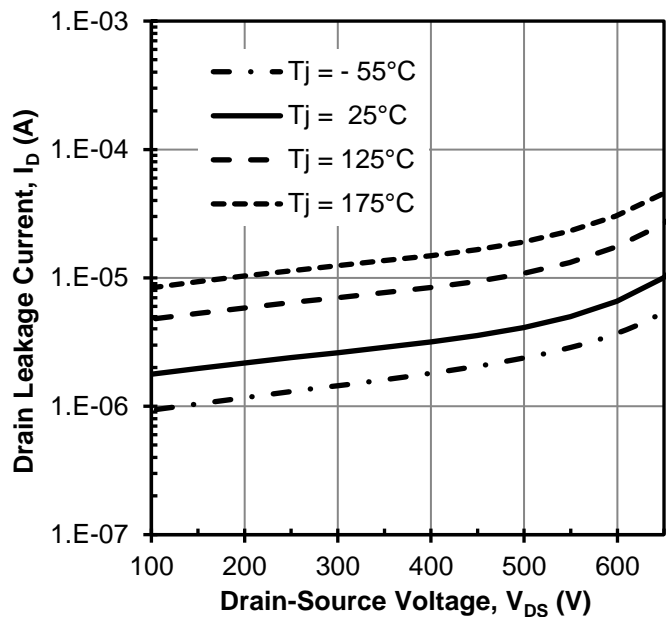
**Figure 1 Typical output characteristics**  
at  $T_J = -55^\circ\text{C}$



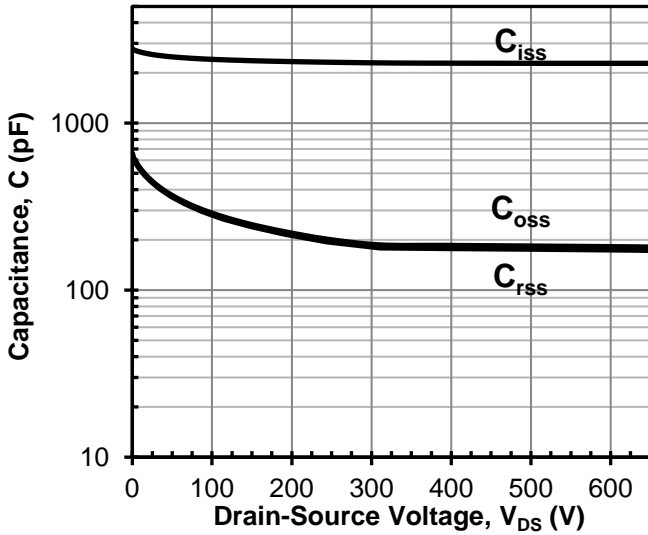
**Figure 2 Typical output characteristics**  
at  $T_J = 25^\circ\text{C}$



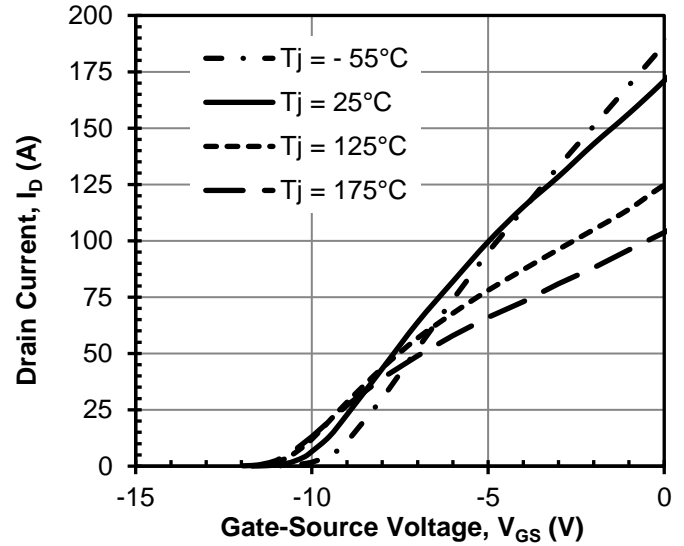
**Figure 3 Typical output characteristics**  
at  $T_J = 175^\circ\text{C}$



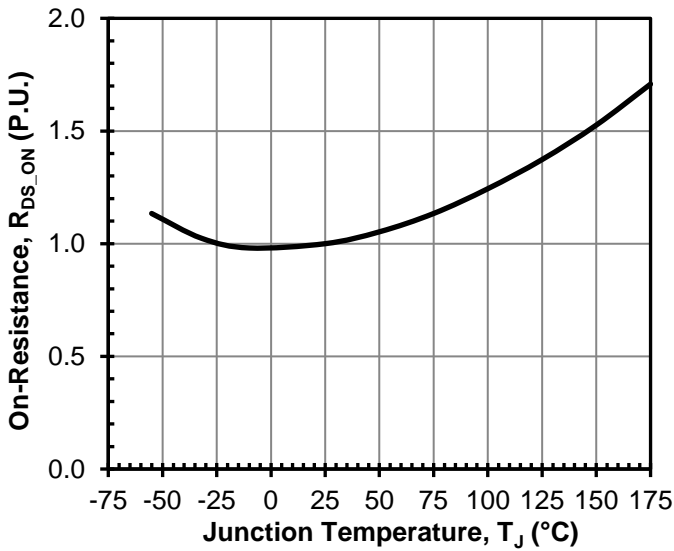
**Figure 4 Typical drain-source leakage**  
at  $V_{GS} = -20\text{V}$



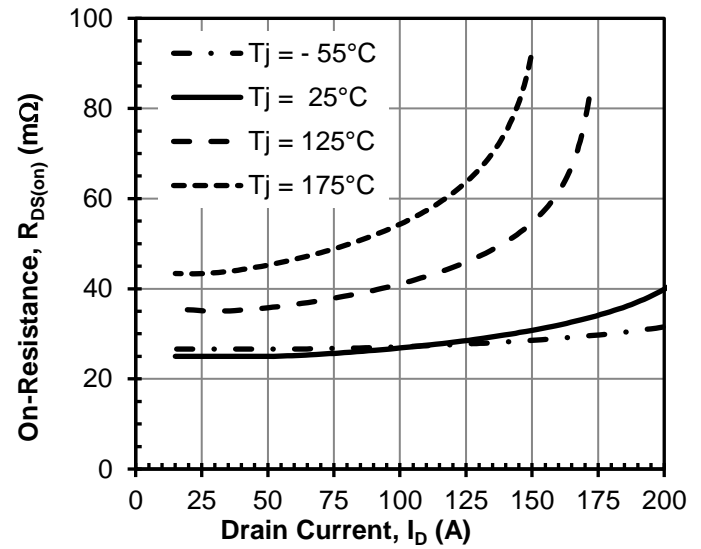
**Figure 5** Typical capacitances at 100kHz and  $V_{GS} = -20V$



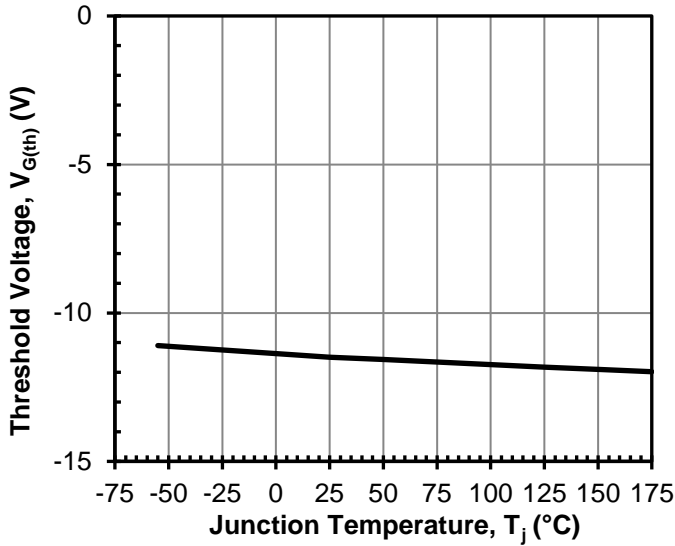
**Figure 6** Typical transfer characteristics at  $V_{DS} = 5V$



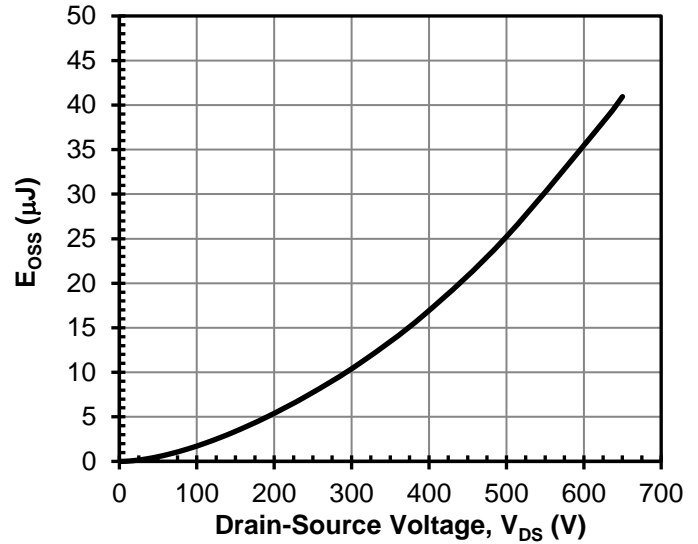
**Figure 7** Normalized on-resistance vs. temperature at  $V_{GS} = 0V$  and  $I_D = 20A$



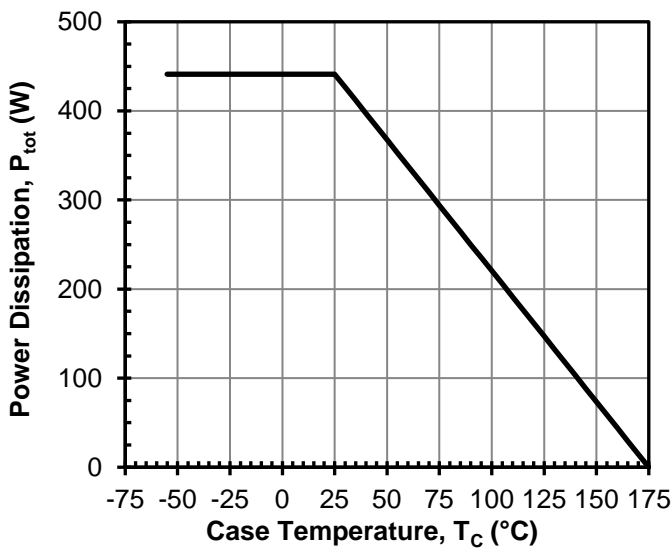
**Figure 8** Typical drain-source on-resistance at  $V_{GS} = 0V$



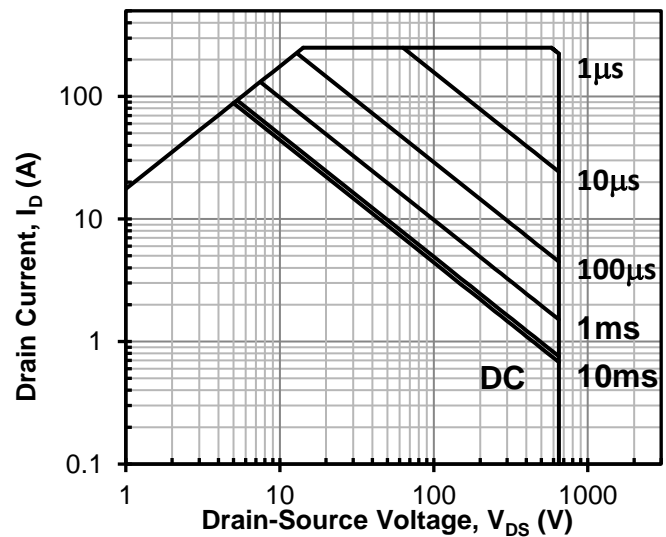
**Figure 9** Threshold voltage vs.  $T_j$   
at  $V_{DS} = 5V$  and  $I_D = 70mA$



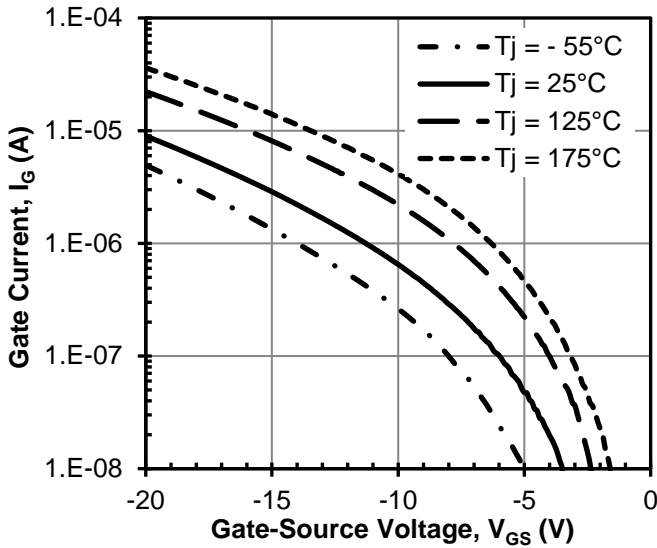
**Figure 10** Typical stored energy in  $C_{oss}$   
at  $V_{GS} = -20V$



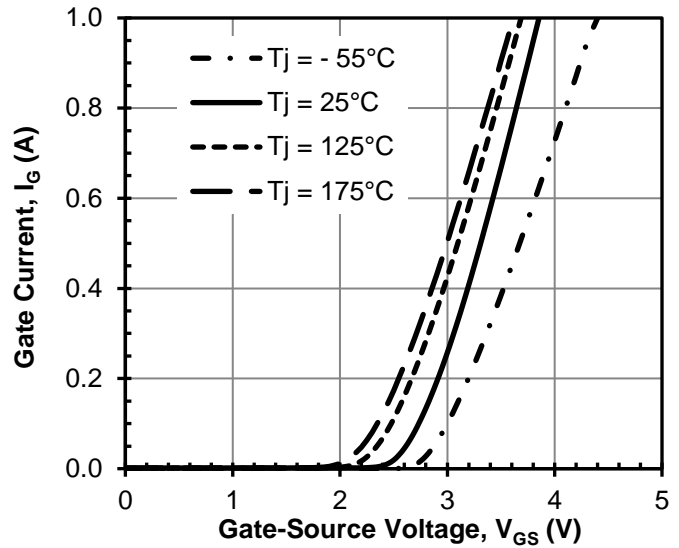
**Figure 11** Total power Dissipation



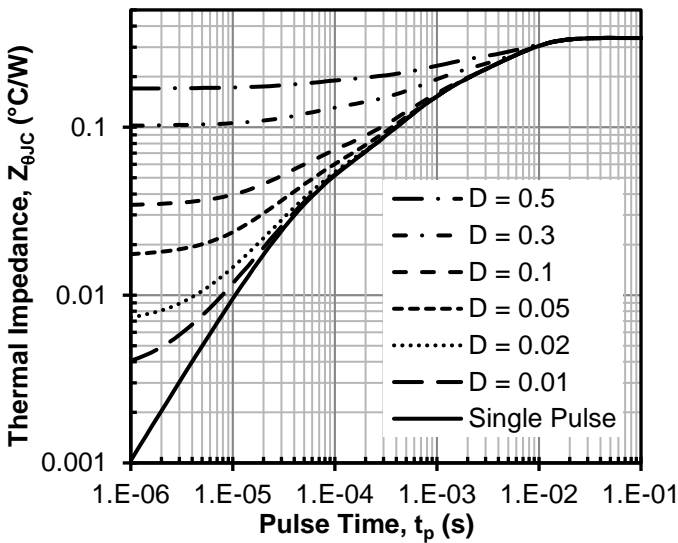
**Figure 12** Safe operation area  
 $T_c = 25^\circ C$ , Parameter  $t_p$



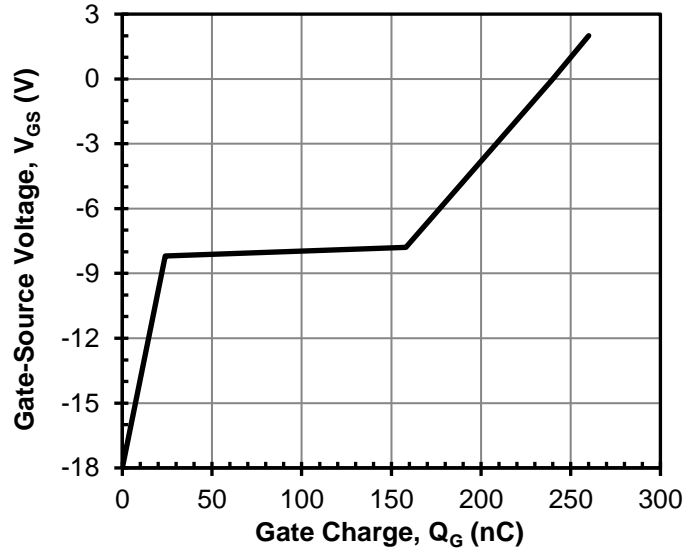
**Figure 13 Typical gate leakage current at  $V_{DS} = 0V$**



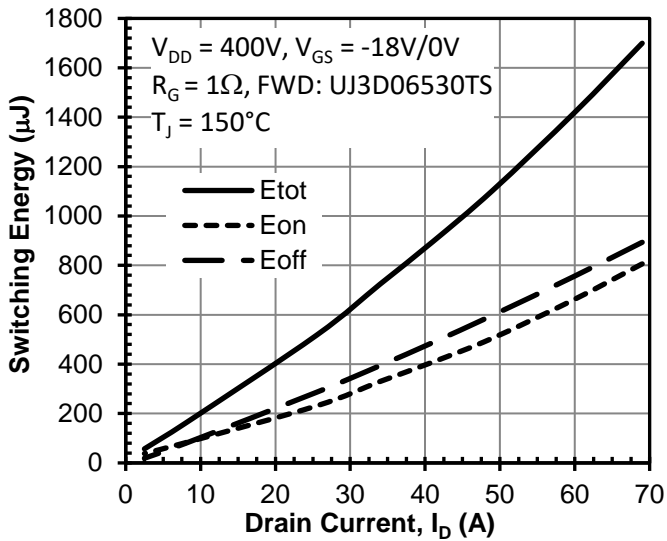
**Figure 14 Typical gate forward current at  $V_{DS} = 0V$**



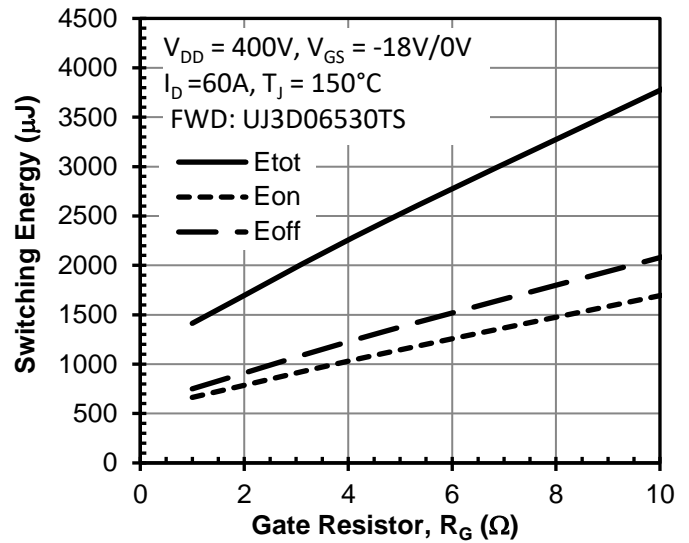
**Figure 15 Maximum transient thermal impedance**



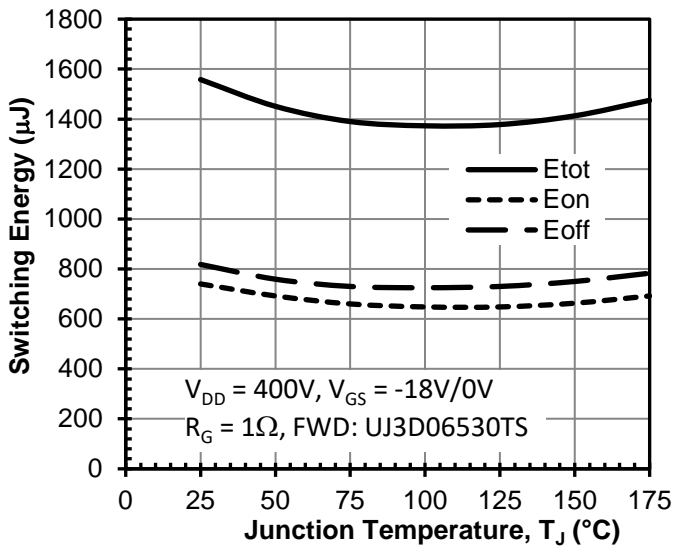
**Figure 16 Typical gate charge at  $V_{DS} = 400V$  and  $I_D = 60A$**



**Figure 17** Clamped inductive switching energy vs. drain current at  $T_J = 150^\circ\text{C}$



**Figure 18** Clamped inductive switching energy vs. gate resistor  $R_G$



**Figure 19** Clamped inductive switching energy vs. junction temperature at  $I_D = 60A$



## Disclaimer

United Silicon Carbide, Inc. reserves the right to change or modify any of the products and their inherent physical and technical specifications without prior notice. United Silicon Carbide, Inc. assumes no responsibility or liability for any errors or inaccuracies within.

Information on all products and contained herein is intended for description only. No license, express or implied, to any intellectual property rights is granted within this document.

United Silicon Carbide, Inc. assumes no liability whatsoever relating to the choice, selection or use of the United Silicon Carbide, Inc. products and services described herein.